

SS24B THRU SS220B
Schottky Barrier Rectifiers



Voltage: 40~200 Volts

Current: 2 Amperes

Polarity And Marking

Package: SMB

Features

- NH'S Plane Schottky Barrier Chip Technology
- Low Forward Voltage Drop For High Efficiency
- Low Power Loss For High Reliability
- High Frequency Switching Speed

Mechanical Data

- Case:** Molded With UL-94 Class V-0 Recognized, RoHS-Compliant
- Polarity:** Look At The Polarity And Marking On The Right
- Terminals:** Tin Plated Leads, Solderable Per J-STD-002 And JESD22-B102
- Weight:** App. 0.095 Grams (0.003351 Ounce)

Typical Applications

- Switch Mode Power Supplies (SMPS)
- Fast Chargers
- LED Driver And Monitor Lighting
- Automotive Electronics And Charging Posts



Remark:

- NH=Niuhan Trademark
- FF=Product Line Code, According To Actual Changes
YWW=Date Code, According To Actual Changes
- SS2xB=Model, x=4, 45, 6, 8, 10, 15, 20
- White band denotes cathode

Single Phase, Half Wave, 60Hz, Resistive Or Inductive Load. For Capacitive Load, Derate Current By 20%

Maximum Ratings (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	SS 24B	SS 245B	SS 26B	SS 28B	SS 210B	SS 215B	SS 220B	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	40	45	60	80	100	150	200	V
Maximum RMS Voltage		V_{RMS}	28	32	42	56	70	105	140	V
Maximum DC Blocking Voltage		V_{DC}	40	45	60	80	100	150	200	V
Maximum Average Forward Rectified Current		$I_{F(AV)}$	2							A
Peak Forward Surge Current	8.3ms Single Half Sine-wave Superimposed On Rate Load	I_{FSM}	50							A
Current Squared Time	$t < 8.3$ ms	$I^2 t$	10.4							A ² sec

Electrical Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	SS 24B	SS 245B	SS 26B	SS 28B	SS 210B	SS 215B	SS 220B	Unit
Maximum Instantaneous Forward Voltage	$I_F = 2.0$ A	V_F	0.55		0.70	0.85		0.90		V
Maximum DC Reverse Current at Rated DC Blocking Voltage	Ta=25°C $V_R = V_{RRM}$ Ta=110°C $V_R = V_{RRM} * 80\%$	I_{RRM}	100		80	50		10		uA
			10		8	5		3		mA
Typical Junction Capacitance	4 V, 1MHz	C_J	100		90	80		50		pF

Thermal Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	SS 24B	SS 245B	SS 26B	SS 28B	SS 210B	SS 215B	SS 220B	Unit
Operating Junction Temperature Range		T _J	-55~125			-55~150		-55~175		℃
Storage Temperature Range		T _{STD}	-55~125			-55~150		-55~175		
Thermal Resistance Junction To Ambient With Steady-State	Still Air Environment With Ta=25℃	R _{θJA}	63.0							℃/W
Thermal Resistance Junction-Case With Steady-State	Device Mounted On 1 in2 FR-4 Board With 2oz. Copper	R _{θJC}	18.0							

Notes: 1. Pulse Test: 300 Us Pulse Width, 1% Duty Cycle

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Typical Characteristics Curves

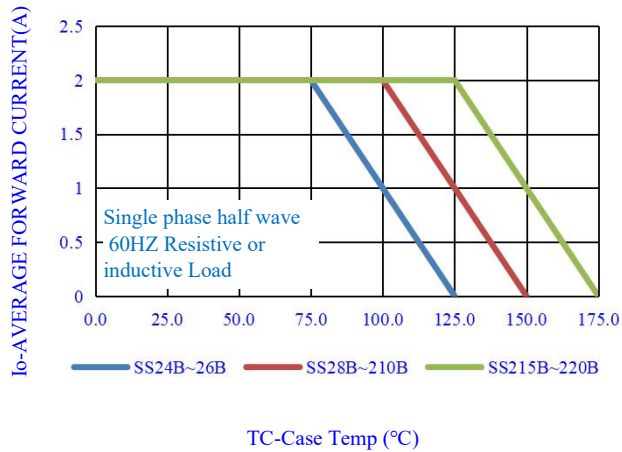


Fig.1-FORWARD CURRENT DERATING CURVE

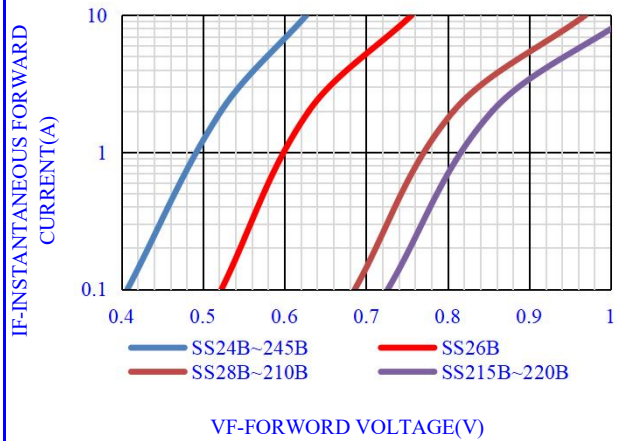


Fig.2- TYPICAL INSTANTANEOUS FORWARD

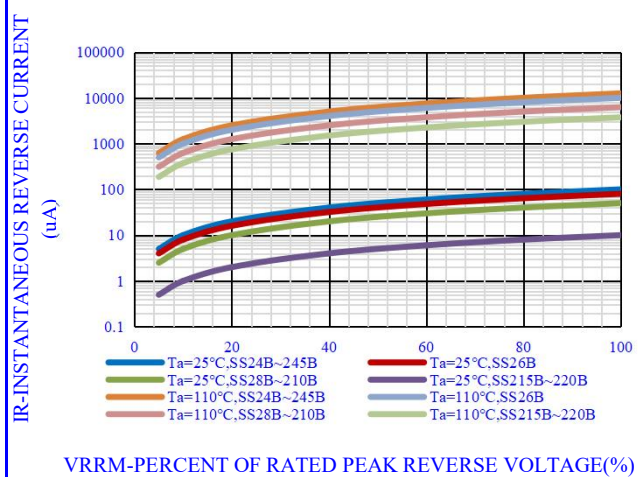


Fig.3- TYPICAL REVERSE CHARACTERISTICS

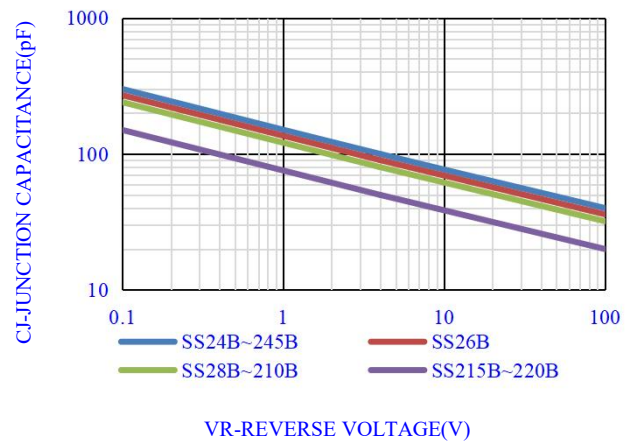


Fig.4- TYPICAL JUNCTION CAPACITANCE

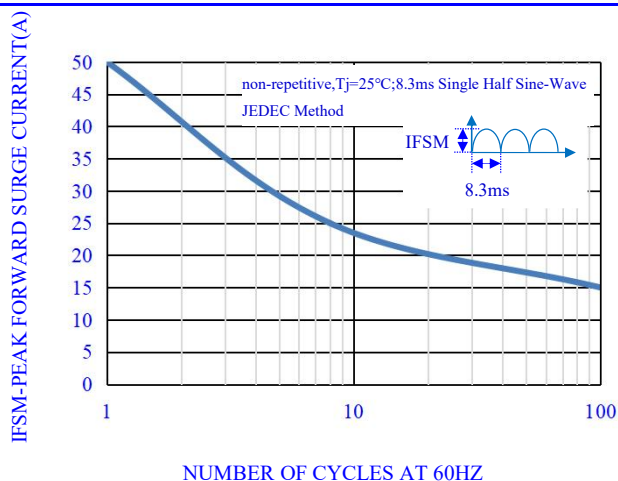


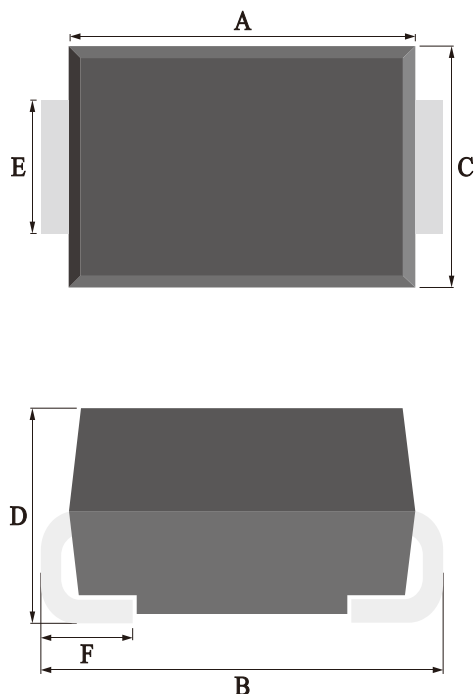
Fig.5-MAX. NON-REPETITIVE SURGE CURRENT

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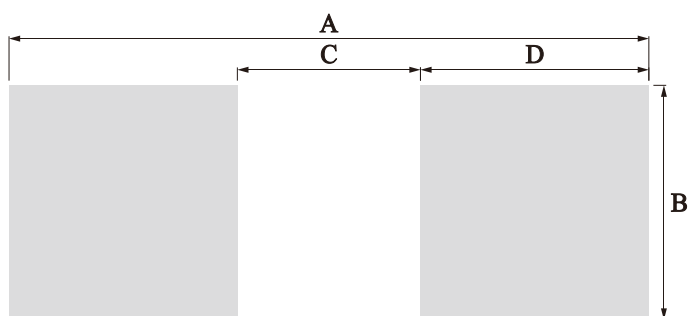
OUTLINE DRAWINGS



SMB

OUTLINE DIMENSIONS						
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.00	-	4.70	0.1575	-	1.8504
B	5.00	-	5.59	1.9685	-	2.2008
C	3.30	-	3.94	1.2992	-	1.5512
D	2.10	-	2.45	0.8268	-	0.9646
E	1.90	-	2.11	0.7480	-	0.8307
F	0.76	-	1.50	0.2992	-	0.5906

RECOMMENDED LAYOUT DRAWINGS



SMB

OUTLINE DIMENSIONS						
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	6.34	-	-	2.4961	-
B	-	2.72	-	-	1.0709	-
C	-	1.76	-	-	0.6929	-
D	-	2.29	-	-	0.9016	-

PACKING INFORMATION

Package Code	Package Method	Min. Pack. Size (mm)	Quantity (Pcs/Min. Pack.)	Inner Box Size L×W×H(mm)	Quantity (Pcs/Inner Box)	Outer Carton Size L×W×H(mm)	Quantity (Pcs/Carton)
SMB	T/R	Φ330	3000	340×340×42	6000	365×365×360	48000

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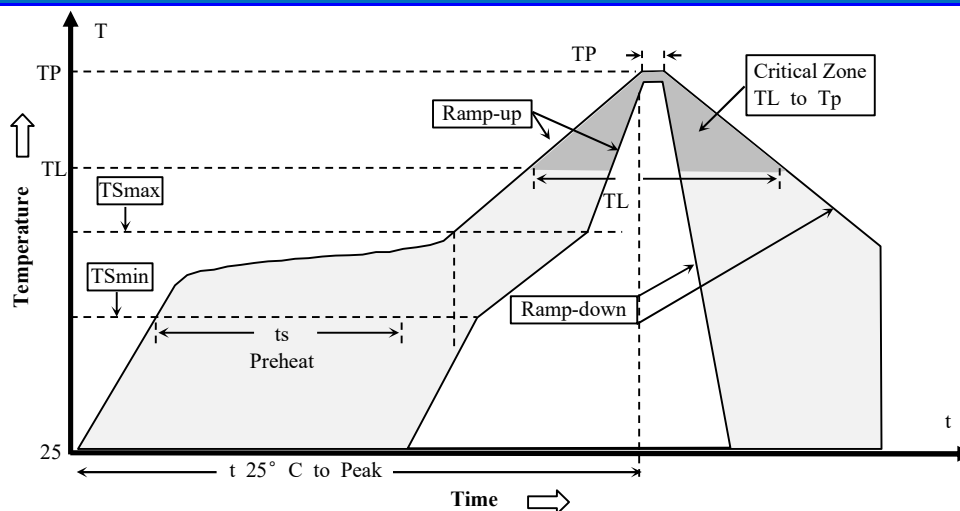
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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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